

Mill-Max "Pick-n'Place DIP Sockets for Automated SMT Assembly



Designed for automated board assembly equipment by companies such as Fuji and Panasonic, these sockets feature a top pad for vacuum pick-up. The closed frame design allows the machine's vision system to position and place the socket accurately on the PC board. On the larger sizes, there's also a vacuum pad beneath the socket for horizontal transfer on Fuji equipment.

Mill-Max "pick & place" DIP sockets contain unique "floating" contacts which compensate for the effects of unevenly dispensed solder paste. These contacts allow .008" vertical travel, reacting to capillary action as the solder paste melts. The insulator is molded from high temperature Nylon 46 material, suitable for vapor phase and infra-red reflow soldering. All products feature the world famous Mill-Max "multi-finger" beryllium copper contact renowned for its greater compliancy and proven reliability.

Mill-Max supplies "pick and place" DIP sockets on 13" diameter reels, from 8 pins to 32 pins with tape widths from 16mm to 56mm. The sockets are protected by a clear, heat sealed cover tape which is peeled back when the sockets are presented to the vacuum head.

For more information, please visit mill-max.com/PR415.

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Mill-Max Mfg. Corp. • 190 Pine Hollow Road, Oyster Bay, NY 11771-0300 516-922-6000 • Fax: 516-922-9253 • www.mill-max.com



